

								μ
								μ

Fig.1 Maximum Average Forward Current Rating

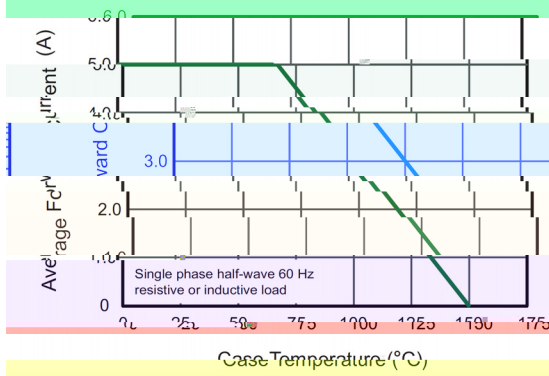


Fig.2 Typical Reverse Characteristics

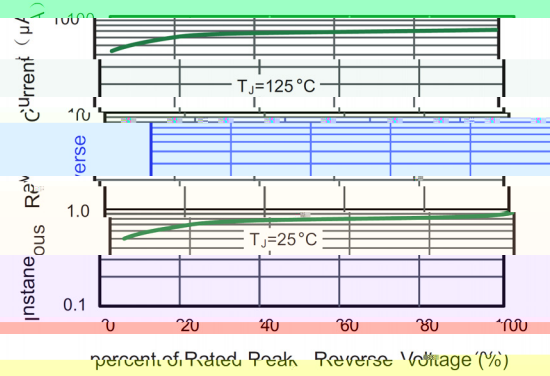


Fig.3 Typical Instantaneous Forward Characteristics

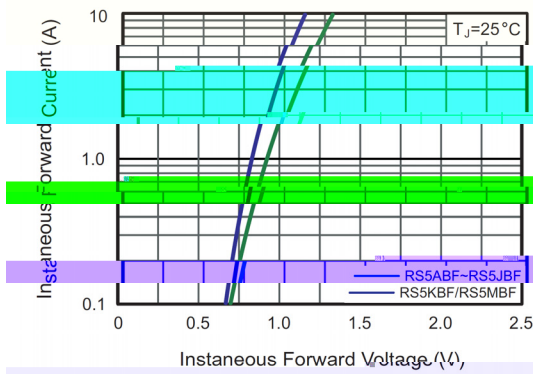


Fig.4 Typical Junction Capacitance

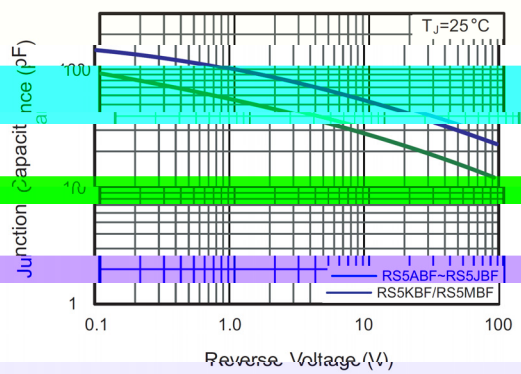
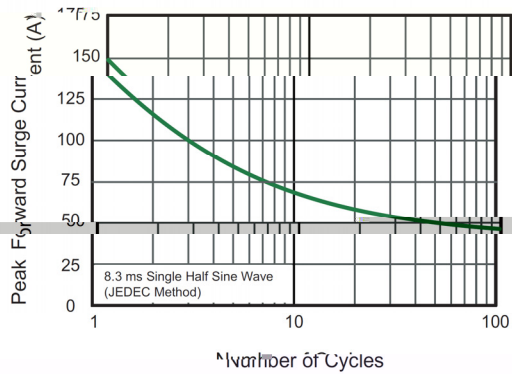
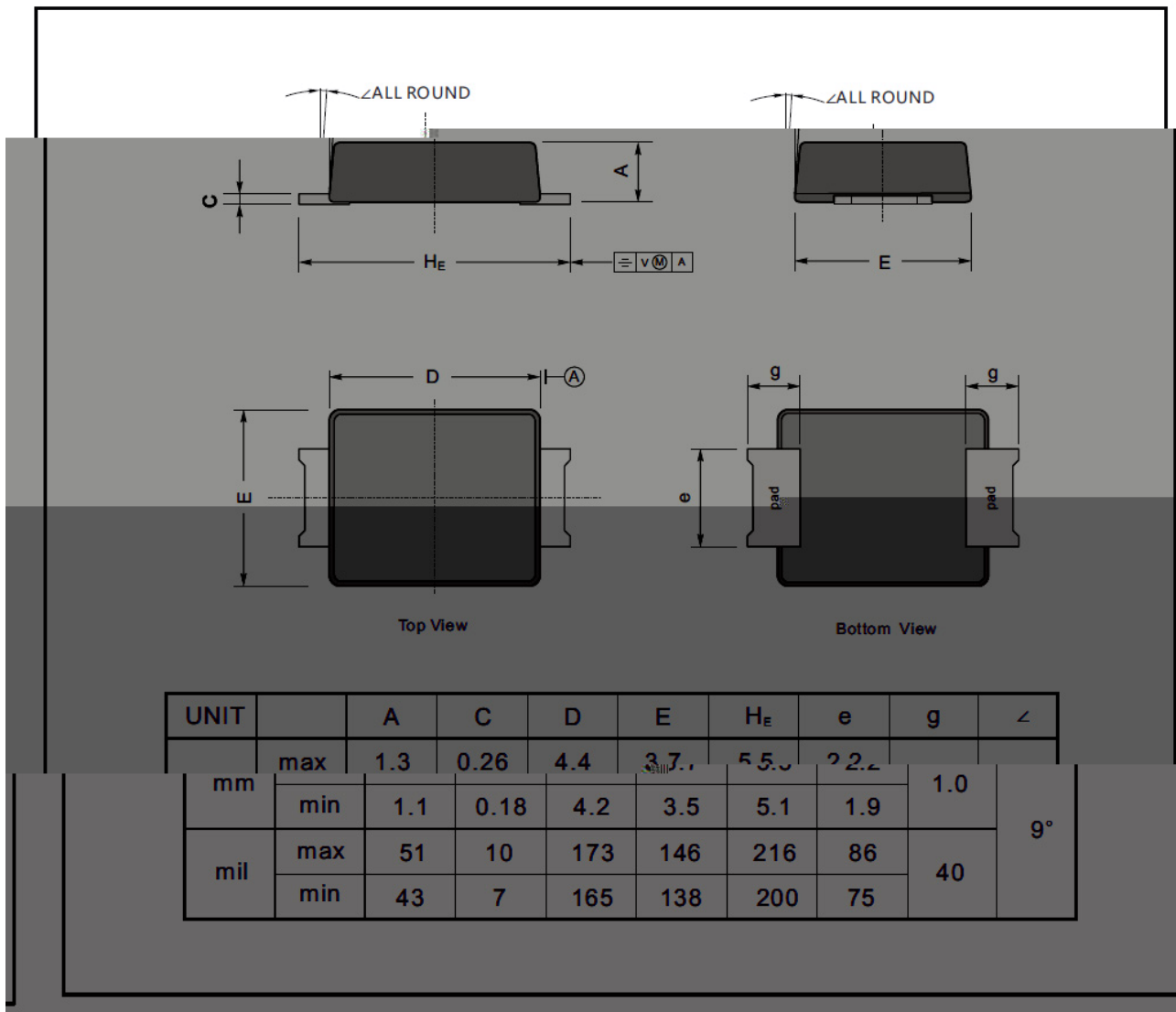
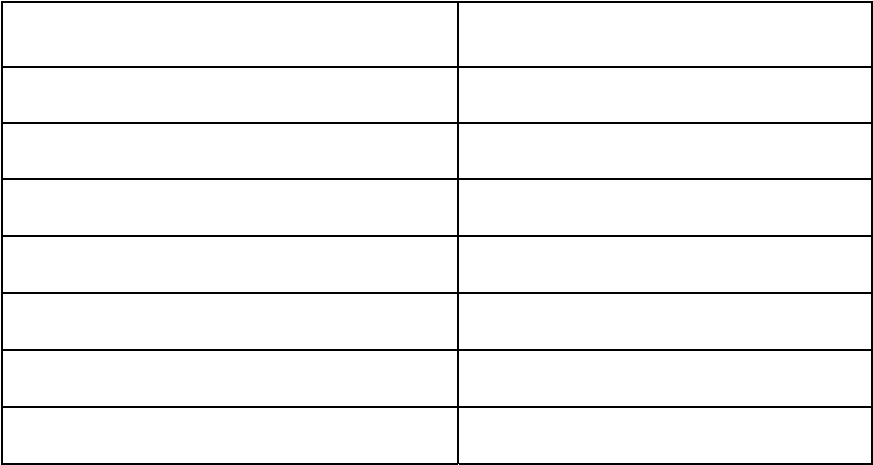


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

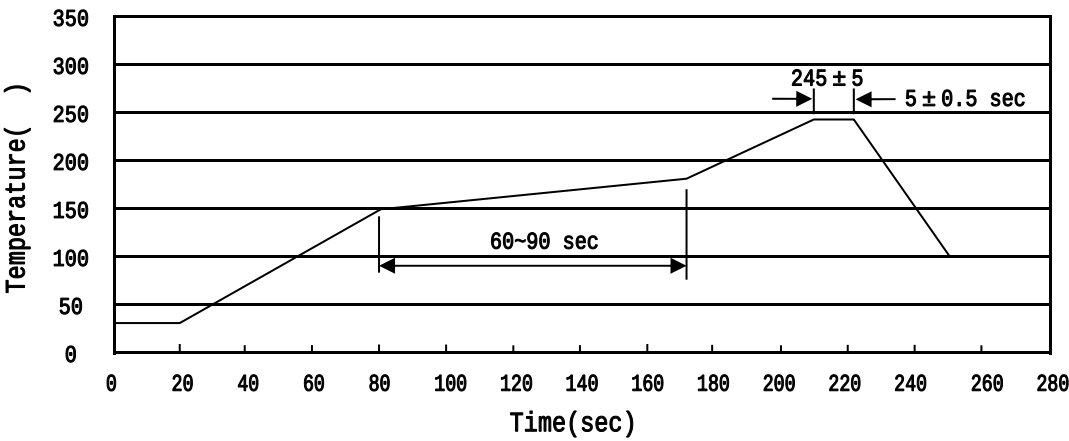


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Temperature Profile for IR Reflow Soldering(Pb-Free)



	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box